

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

SHI-QING WANG, ET AL

Docket: 30-4687 (4780)

Serial Number: 09/328,646

Group Art Unit: 2811

Filed: June 9, 1999

Examiner: H. Vu

For: INTEGRATED CIRCUITS WITH MULTIPLE LOW DIELECTRIC-
CONSTANT INTER-METAL DIELECTRICS

FAX COVER SHEET

TO: Commissioner for Patents
Washington, D.C. 20231

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DATE: November 14, 2002

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AMENDMENT

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Commissioner for Patents
Washington, D.C. 20231

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Sir:

In response to the Office Action mailed August 14, 2002, please amend the above identified patent application as follows:

In the claims:

CLEAN COPY OF THE AMENDED CLAIMS

23. (Amended) An integrated circuit structure which comprises a substrate and
(a) an organic layer on a surface of the substrate which comprises a pattern of
metal lines on the substrate and an organic dielectric on the substrate surface
between the metal lines, and wherein the organic dielectric comprises a dielectric
selected from the group consisting of alkoxysilane polymers, organic siloxanes,